IS62C64

8K x 8 LOW POWER CMOS STATIC RAM

FEATURES

- CMOS low power operation
  - — 400 mW (max.) operating
  - — 25 mW (max.) standby
- Automatic power-down when chip is deselected
- TTL compatible interface levels
- Single 5V power supply
- Fully static operation: no clock or refresh required
- Three-state outputs
- Two Chip Enables ($\overline{CE1}$ and CE2) for simple memory expansion
- Industrial temperature available

DESCRIPTION

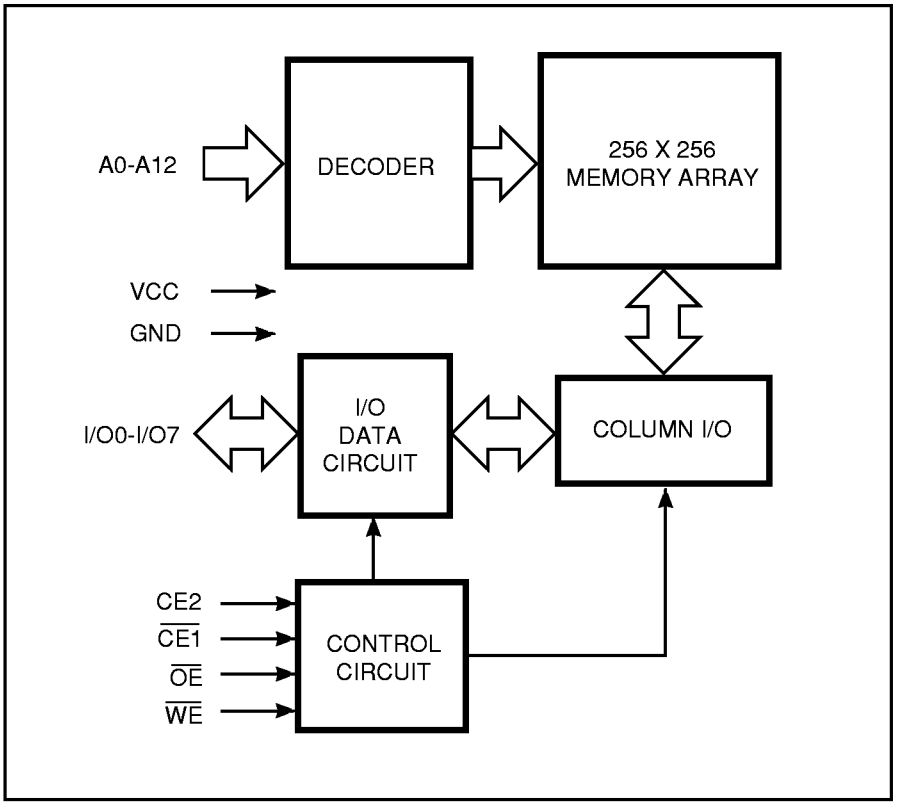
The *ISSI* IS62C64 is a low power, 8,192-word by 8-bit static RAM. It is fabricated using *ISSI*'s high-performance CMOS technology.

When $\overline{CE1}$ is HIGH or CE2 is LOW (deselected), the device assumes a standby mode at which the power dissipation is reduced to 25 µW (typical) with CMOS input levels.

Easy memory expansion is provided by using two Chip Enable inputs, $\overline{CE1}$ and CE2. The active LOW Write Enable ($\overline{WE}$) controls both writing and reading of the memory.

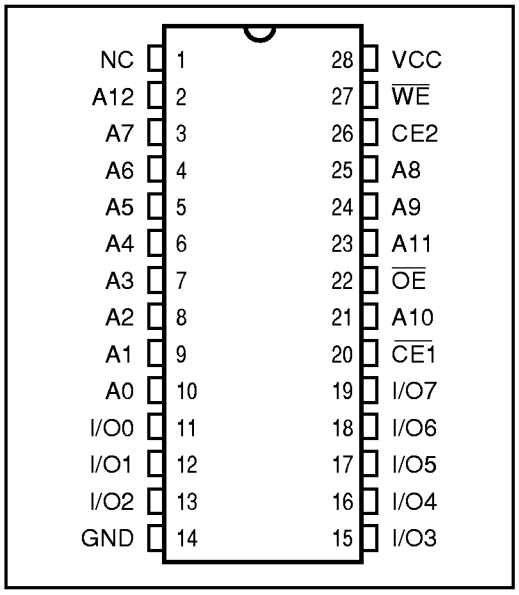
The IS62C64 is packaged in the JEDEC standard 28-pin, 600-mil DIP and SOP surface mount packages.

FUNCTIONAL BLOCK DIAGRAM



PIN CONFIGURATION

28-Pin DIP and SOJ



PIN DESCRIPTIONS

A0-A12	Address Inputs
$\overline{CE1}$	Chip Enable 1 Input
CE2	Chip Enable 2 Input
$\overline{OE}$	Output Enable Input
$\overline{WE}$	Write Enable Input
I/O0-I/O7	Input/Output
Vcc	Power
GND	Ground

TRUTH TABLE

Mode	$\overline{WE}$	$\overline{CE1}$	CE2	$\overline{OE}$	I/O Operation	Vcc Current
Not Selected	X	H	X	X	High-Z	I_{SB1}, I_{SB2}
(Power-down)	X	X	L	X	High-Z	I_{SB1}, I_{SB2}
Output Disabled	H	L	H	H	High-Z	I_{CC1}, I_{CC2}
Read	H	L	H	L	D_{OUT}	I_{CC1}, I_{CC2}
Write	L	L	H	X	D_{IN}	I_{CC1}, I_{CC2}

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Parameter	Value	Unit
V_{TERM}	Terminal Voltage with Respect to GND	–0.5 to +7.0	V
T_{BIAS}	Temperature Under Bias	–55 to +125	°C
T_{STG}	Storage Temperature	–65 to +150	°C
P_T	Power Dissipation	1.0	W
I_{OUT}	DC Output Current (LOW)	20	mA

Notes:

1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

OPERATING RANGE

Range	Ambient Temperature	Vcc
Commercial	0°C to +70°C	5V ± 10%
Industrial	–40°C to +85°C	5V ± 10%

DC ELECTRICAL CHARACTERISTICS (Over Operating Range)

Symbol	Parameter	Test Conditions		Min.	Max.	Unit
V_{OH}	Output HIGH Voltage	V_{CC} = Min., I_{OH} = –1.0 mA		2.4	—	V
V_{OL}	Output LOW Voltage	V_{CC} = Min., I_{OL} = 2.1 mA		—	0.4	V
V_{IH}	Input HIGH Voltage			2.2	V_{CC} + 0.5	V
V_{IL}	Input LOW Voltage[1]			–0.5	0.8	V
I_{LI}	Input Leakage	GND ≤ V_{IN} ≤ V_{CC}	Com.	–2	2	µA
			Ind.	–10	10	
I_{LO}	Output Leakage	GND ≤ V_{OUT} ≤ V_{CC}, Outputs Disabled	Com.	–2	2	µA
			Ind.	–10	10	

Notes:
1. V_{IL} = –3.0V for pulse width less than 10 ns.

POWER SUPPLY CHARACTERISTICS[1] (Over Operating Range)

				-45 ns		-70 ns		-100 ns		
Symbol	Parameter	Test Conditions		Min.	Max.	Min.	Max.	Min.	Max.	Unit
I_{CC1}	Vcc Operating Supply Current	V_{CC} = Max., I_{OUT} = 0 mA, f = 0	Com.	—	65	—	65	—	65	mA
			Ind.	—	75	—	75	—	75	
I_{CC2}	Vcc Dynamic Operating Supply Current	V_{CC} = Max., I_{OUT} = 0 mA, f = f_{MAX}	Com.	—	90	—	80	—	70	mA
			Ind.	—	100	—	90	—	80	
I_{SB1}	TTL Standby Current (TTL Inputs)	V_{CC} = Max., V_{IN} = V_{IH} or V_{IL}, $\overline{CE1}$ ≥ V_{IH} or CE2 ≤ V_{IL}, f = 0	Com.	—	20	—	20	—	20	mA
			Ind.	—	30	—	30	—	30	
I_{SB2}	CMOS Standby Current (CMOS Inputs)	V_{CC} = Max., $\overline{CE1}$ ≥ V_{CC} – 0.2V, CE2 ≤ 0.2V, V_{IN} ≥ V_{CC} – 0.2V, or V_{IN} ≤ 0.2V, f = 0	Com.	—	5	—	5	—	5	mA
			Ind.	—	10	—	10	—	10	

Notes:
1. At f = f_{MAX}, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.

CAPACITANCE[1,2]

Symbol	Parameter	Conditions	Max.	Unit
C_{IN}	Input Capacitance	V_{IN} = 0V	5	pF
C_{OUT}	Output Capacitance	V_{OUT} = 0V	7	pF

Notes:
1. Tested initially and after any design or process changes that may affect these parameters.
2. Test conditions: T_A = 25°C, f = 1 MHz, Vcc = 5.0V.

READ CYCLE SWITCHING CHARACTERISTICS[1] (Over Commercial Operating Range)

Symbol	Parameter	-45 ns Min.	-45 ns Max.	-70 ns Min.	-70 ns Max.	-100 ns Min.	-100 ns Max.	Unit
t_{RC}	Read Cycle Time	45	—	70	—	100	—	ns
t_{AA}	Address Access Time	—	45	—	70	—	100	ns
t_{OHA}	Output Hold Time	3	—	3	—	3	—	ns
t_{ACE1}	$\overline{CE1}$ Access Time	—	45	—	70	—	100	ns
t_{ACE2}	CE2 Access Time	—	45	—	70	—	100	ns
t_{DOE}	$\overline{OE}$ Access Time	—	25	—	35	—	50	ns
t_{LZOE}[2]	$\overline{OE}$ to Low-Z Output	0	—	0	—	0	—	ns
t_{HZOE}[2]	$\overline{OE}$ to High-Z Output	—	20	—	25	—	25	ns
t_{LZCE1}[2]	$\overline{CE1}$ to Low-Z Output	3	—	3	—	3	—	ns
t_{LZCE2}[2]	CE2 to Low-Z Output	3	—	3	—	3	—	ns
t_{HZCE}[2]	$\overline{CE1}$ or CE2 to High-Z Output	—	20	—	25	—	25	ns
t_{PU}[3]	$\overline{CE1}$ or CE2 to Power-Up	0	—	0	—	0	—	ns
t_{PD}[3]	$\overline{CE1}$ or CE2 to Power-Down	—	30	—	50	—	50	ns

Notes:
1. Test conditions assume signal transition times of 5 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading specified in Figure 1a.
2. Tested with the load in Figure 1b. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.
3. Not 100% tested.

AC TEST CONDITIONS

Parameter	Unit
Input Pulse Level	0V to 3.0V
Input Rise and Fall Times	5 ns
Input and Output Timing and Reference Level	1.5V
Output Load	See Figures 1a and 1b

AC TEST LOADS

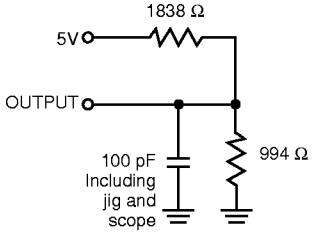


Figure 1a.

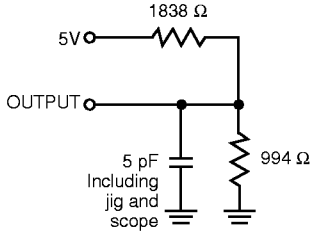
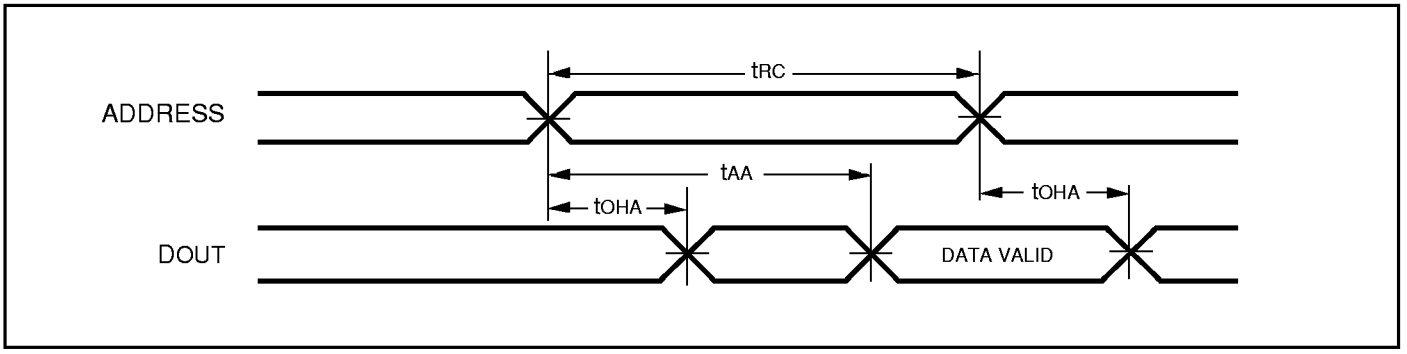


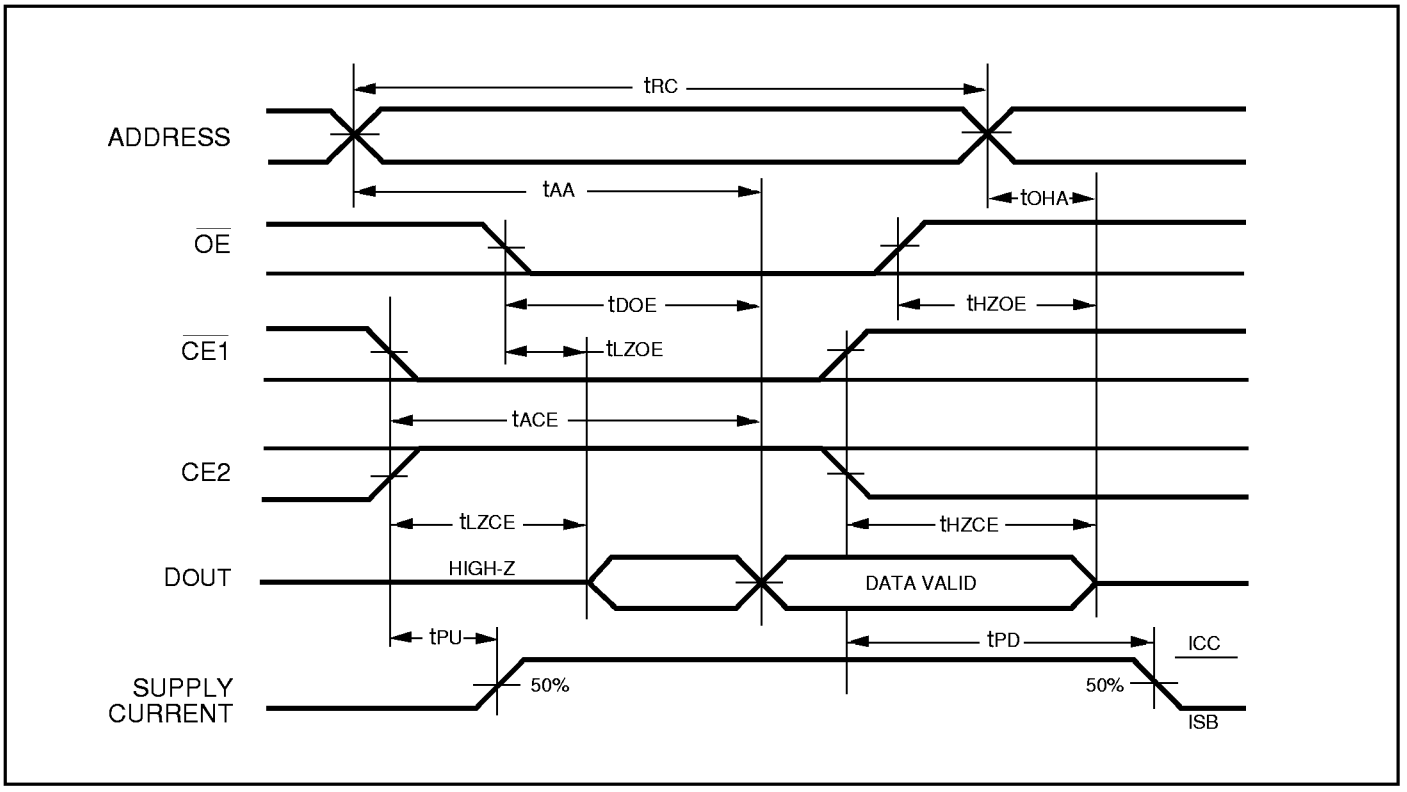
Figure 1b.

AC WAVEFORMS

READ CYCLE NO. 1[1,2]



READ CYCLE NO. 2[1,3]



Notes:
1. $\overline{WE}$ is HIGH for a Read Cycle.
2. The device is continuously selected. $\overline{OE}$, $\overline{CE1}$ = V_{IL}, CE2 = V_{IH}.
3. Address is valid prior to or coincident with $\overline{CE1}$ LOW and CE2 HIGH transitions.

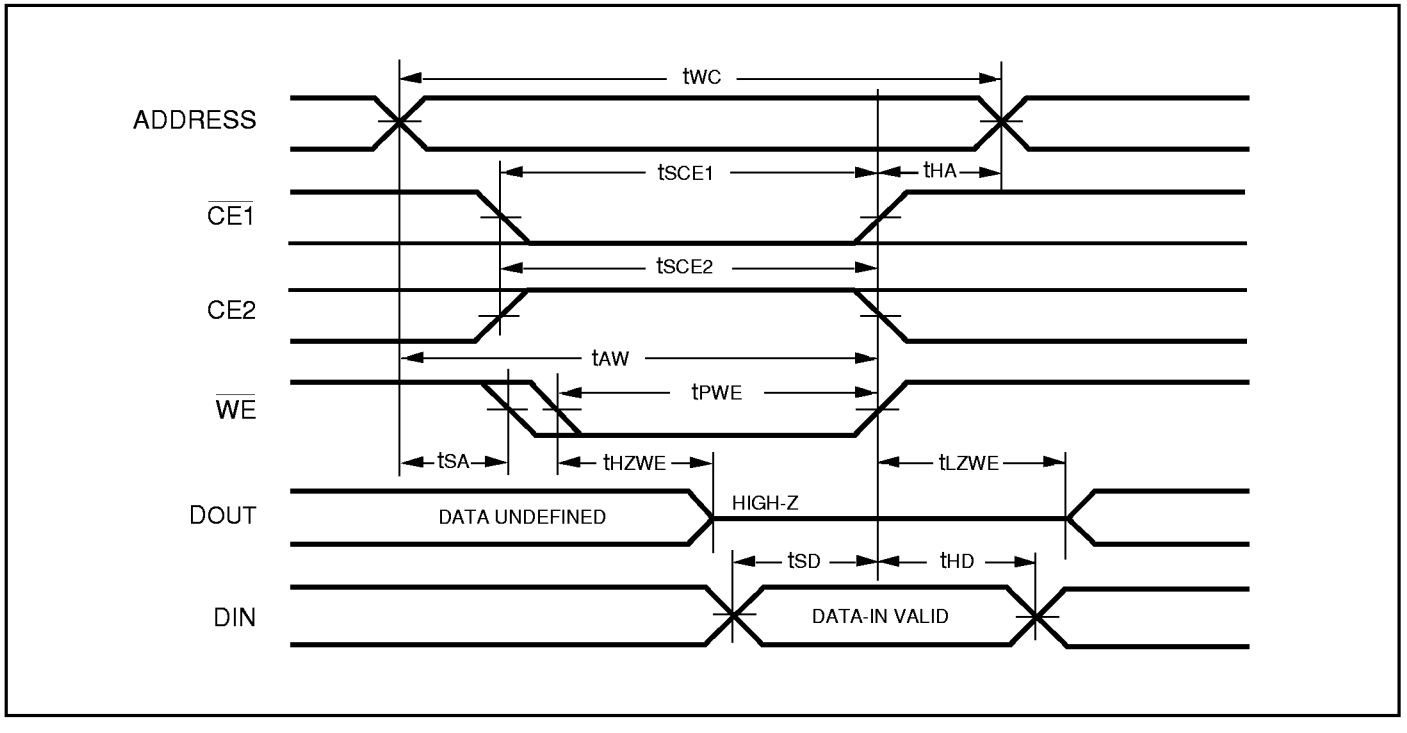
WRITE CYCLE SWITCHING CHARACTERISTICS[1,3] (Over Commercial Operating Range)

Symbol	Parameter	-45 ns Min.	-45 ns Max.	-70 ns Min.	-70 ns Max.	-100 ns Min.	-100 ns Max.	Unit
t_{WC}	Write Cycle Time	45	—	70	—	100	—	ns
t_{SCE1}	$\overline{CE1}$ to Write End	35	—	60	—	80	—	ns
t_{SCE2}	CE2 to Write End	35	—	60	—	80	—	ns
t_{AW}	Address Setup Time to Write End	35	—	60	—	80	—	ns
t_{HA}	Address Hold from Write End	0	—	0	—	0	—	ns
t_{SA}	Address Setup Time	0	—	0	—	0	—	ns
t_{PWE}[4]	$\overline{WE}$ Pulse Width	35	—	55	—	60	—	ns
t_{SD}	Data Setup to Write End	25	—	30	—	35	—	ns
t_{HD}	Data Hold from Write End	0	—	0	—	0	—	ns
t_{HZWE}[2]	$\overline{WE}$ LOW to High-Z Output	—	20	—	25	—	25	ns
t_{LZWE}[2]	$\overline{WE}$ HIGH to Low-Z Output	0	—	0	—	0	—	ns

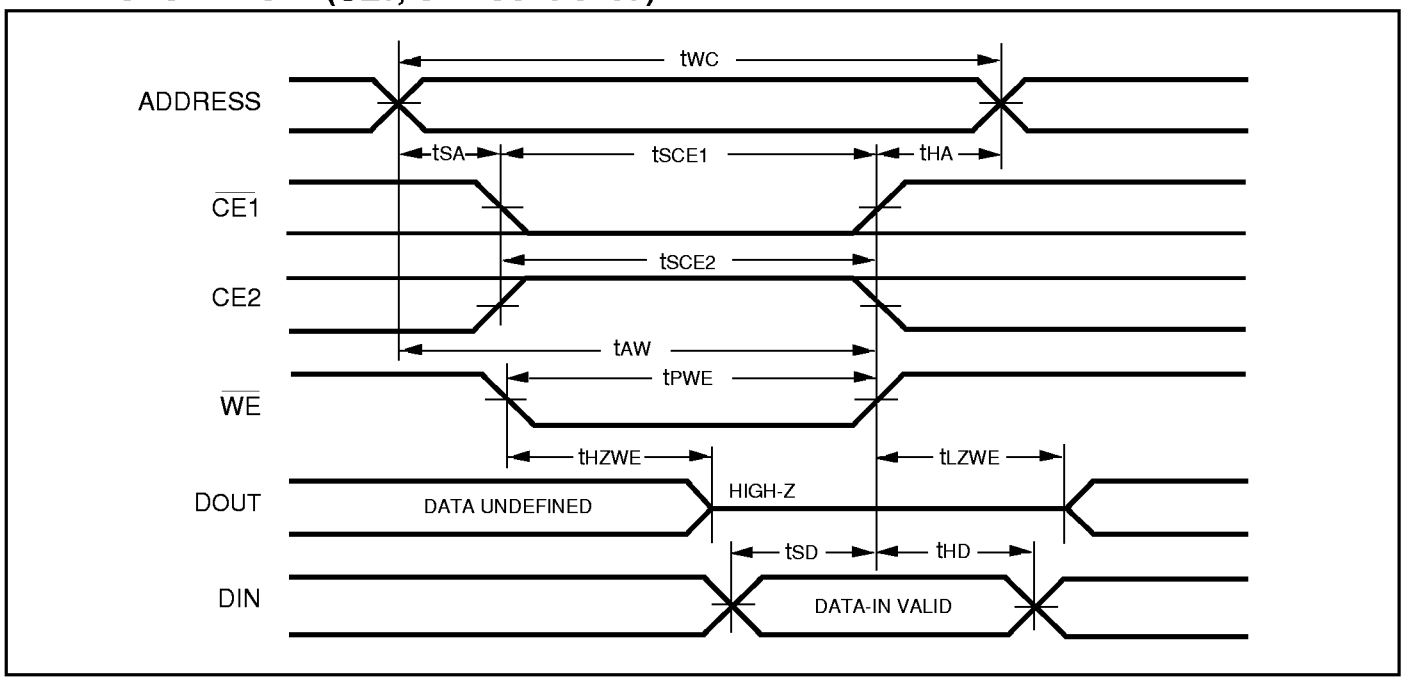
Notes:
1. Test conditions assume signal transition times of 5 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading specified in Figure 1a.
2. Tested with the load in Figure 1b. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.
3. The internal write time is defined by the overlap of $\overline{CE1}$ LOW, CE2 HIGH and $\overline{WE}$ LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the Write.
4. Tested with $\overline{OE}$ HIGH.

AC WAVEFORMS

WRITE CYCLE NO. 1 ($\overline{WE}$ Controlled)[1,2]



WRITE CYCLE NO. 2 ($\overline{CE1}$, CE2 Controlled)[1,2]



Notes:
1. The internal write time is defined by the overlap of $\overline{CE1}$ LOW, CE2 HIGH and $\overline{WE}$ LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the Write.
2. I/O will assume the High-Z state if $\overline{OE}$ = V_{IH}.

ORDERING INFORMATION
Commercial Range: 0°C to +70°C

Speed (ns)	Order Part No.	Package
45	IS62C64-45W	600-mil Plastic DIP
45	IS62C64-45U	330-mil Plastic SOP
70	IS62C64-70W	600-mil Plastic DIP
70	IS62C64-70U	330-mil Plastic SOP
100	IS62C64-100W	600-mil Plastic DIP
100	IS62C64-100U	330-mil Plastic SOP

ORDERING INFORMATION
Industrial Range: –40°C to +85°C

Speed (ns)	Order Part No.	Package
45	IS62C64-45UI	330-mil Plastic SOP
70	IS62C64-70UI	330-mil Plastic SOP
100	IS62C64-100UI	330-mil Plastic SOP

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